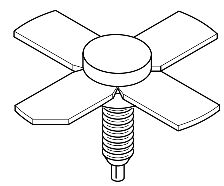
The RF Line
NPN Silicon RF Power Transistors

Designed for 12.5 Vdc UHF large–signal, amplifier applications in industrial and commercial FM equipment operating to 512 MHz.

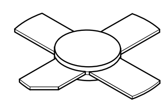
- Guaranteed 12.5 Volt, 512 MHz Characteristics
  Output Power = 5.0 Watts
  Minimum Gain = 10 dB
  Efficiency = 65% (Typ)
- Typical Performance at 512 MHz, 12.5 V, 5.0 W Output = 6.0 dB
- Series Equivalent Large–Signal Characterization
- Gold Metallized, Emitter Ballasted for Long Life and Reliability
- Capable of 30:1 VSWR Load Mismatch at 15.5 V Supply Voltage
- Circuit board photomaster available upon request by contacting RF Tactical Marketing in Phoenix, AZ.

MRF652
MRF652S

5.0 W, 512 MHz
RF POWER
TRANSISTORS
NPN SILICON



CASE 244–04, STYLE 1
MRF652



CASE 249–06, STYLE 1
MRF652S

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	16	Vdc
Collector–Base Voltage	V_{CBO}	36	Vdc
Emitter–Base Voltage	V_{EBO}	4.0	Vdc
Collector Current — Continuous	I_C	2.0	Adc
Total Device Dissipation @ T_C = 25°C Derate above 25°C	P_D	25 143	Watts mW/°C
Storage Temperature Range	T_{stg}	–65 to +150	°C
Operating Junction Temperature	T_J	200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	7.0	°C/W

ELECTRICAL CHARACTERISTICS (TC = 25°C unless otherwise noted)

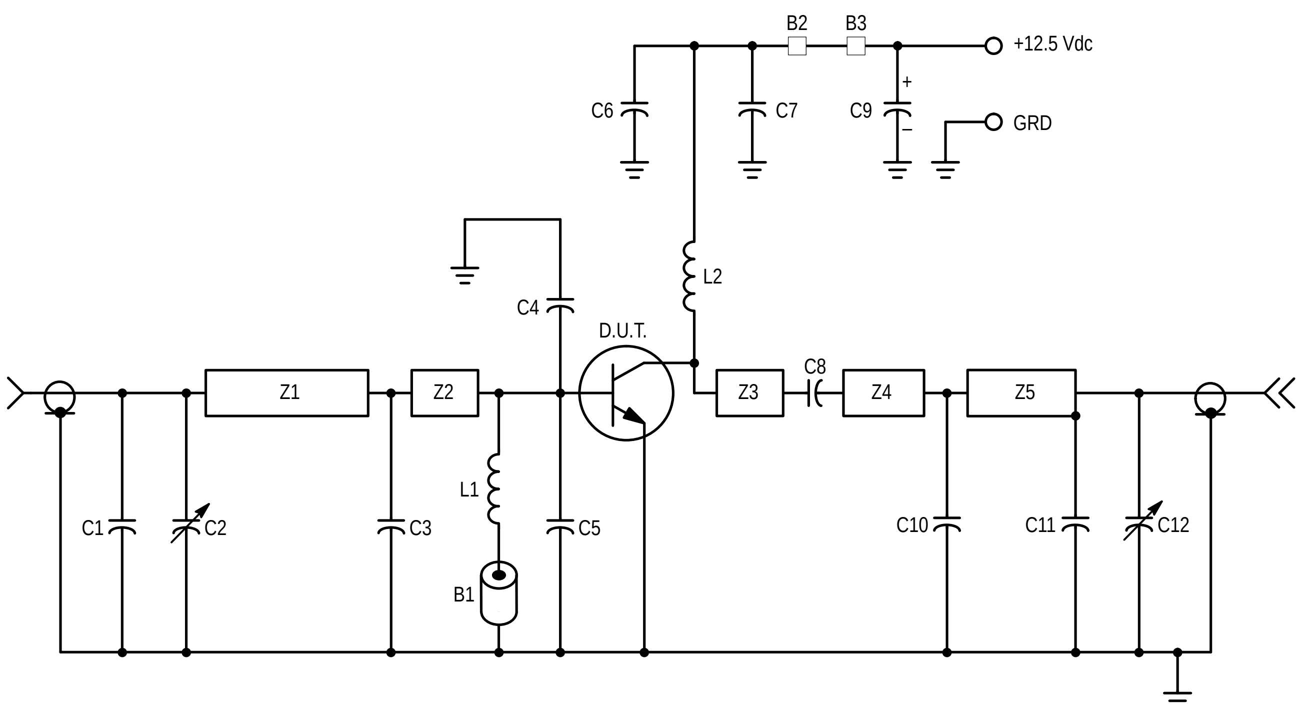
Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage (I_C = 25 mAdc, I_B = 0)	$V_{(BR)CEO}$	16	—	—	Vdc
Collector–Emitter Breakdown Voltage (I_C = 25 mAdc, V_{BE} = 0)	$V_{(BR)CES}$	36	—	—	Vdc
Collector–Base Breakdown Voltage (I_C = 25 mAdc, I_E = 0)	$V_{(BR)CBO}$	36	—	—	Vdc
Emitter–Base Breakdown Voltage (I_E = 5.0 mAdc, I_C = 0)	$V_{(BR)EBO}$	4.0	—	—	Vdc
Collector Cutoff Current (V_{CE} = 15 Vdc, V_{BE} = 0)	I_{CES}	—	—	1.0	mAdc
ON CHARACTERISTICS					
DC Current Gain (I_C = 200 mAdc, V_{CE} = 5.0 Vdc)	h_{FE}	10	—	150	—

(continued)

MOTOROLA

ELECTRICAL CHARACTERISTICS — continued (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
DYNAMIC CHARACTERISTICS					
Output Capacitance (V_{CB} = 15 Vdc, I_E = 0, f = 1.0 MHz)	C_{ob}	—	9.5	15	pF
FUNCTIONAL TESTS					
Common–Emitter Amplifier Power Gain (V_{CC} = 12.5 Vdc, P_{out} = 5.0 W) f = 512 MHz f = 870 MHz	G_{pe}	10 —	11 6.0	— —	dB
Collector Efficiency (V_{CC} = 12.5 Vdc, P_{out} = 5.0 W, f = 512 MHz)	η	60	65	—	%
Load Mismatch (V_{CC} = 15.5 Vdc, P_{in} = 500 mW, f = 512 MHz, VSWR = 30:1, At All Phase Angles)	ψ	No Degradation in Output Power			



B1, B2, B3 — Ferrite Bead
C1 — 7.0 pF Unelco Mica
C2 — 1.0–6.0 pF Johanson Variable 5201
C3 — 15 pF Unelco Mica
C4 — 43 pF Mini–Underwood Mica
C5 — 56 pF Mini–Underwood Mica
C6 — 1000 pF Unelco Mica
C7 — 0.1 μF Ceramic
C8 — 68 pF Mini–Underwood Mica
C9 — 1.0 μF Electrolytic 25 V
C10, C11 — 5.0 pF Unelco Mica
C12 — 1.0–10 pF Johanson Variable 5501
L1, L2 — 6 Turns, 20 AWG Wire 0.125″ ID
Z1, Z2 — 25 Ohm μStripline
Z3, Z4, Z5 — 50 Ohm μStripline
Board — 0.032″ Glass–Teflon

Figure 1. 440–512 MHz Broadband Test Circuit

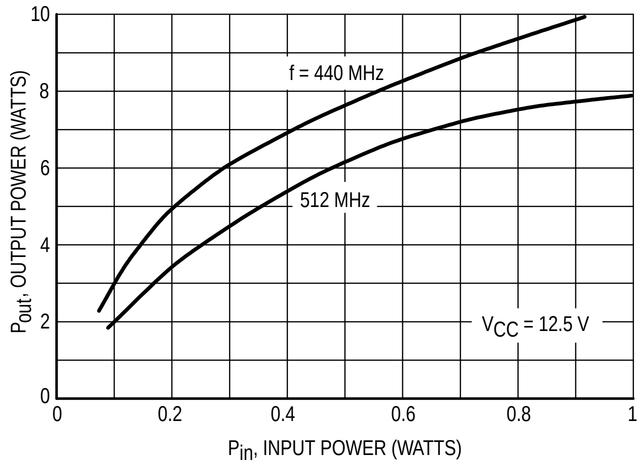


Figure 2. Output Power versus Input Power

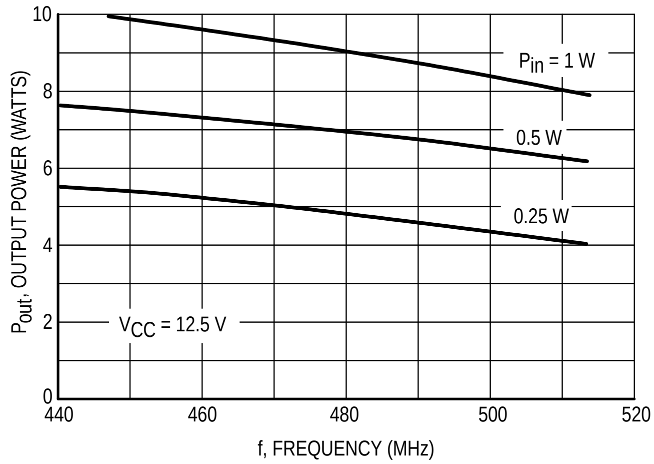


Figure 3. Output Power versus Frequency

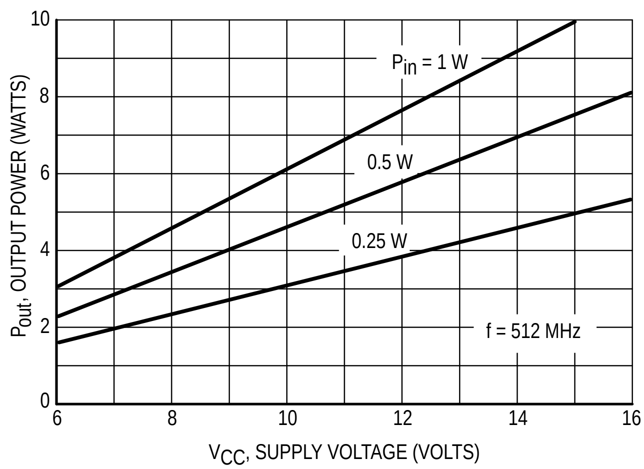


Figure 4. Output Power versus Supply Voltage

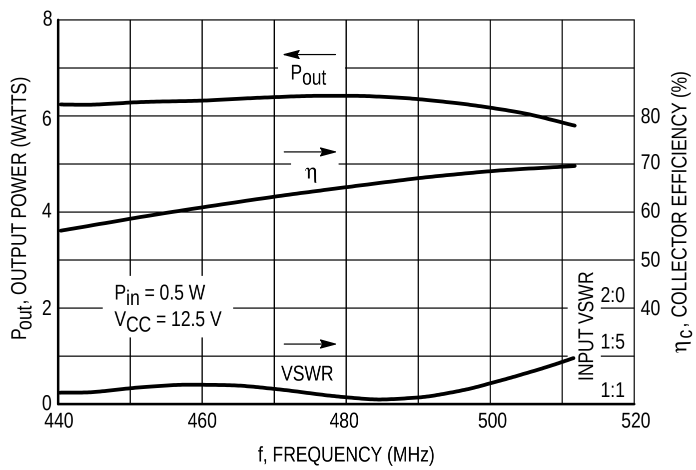
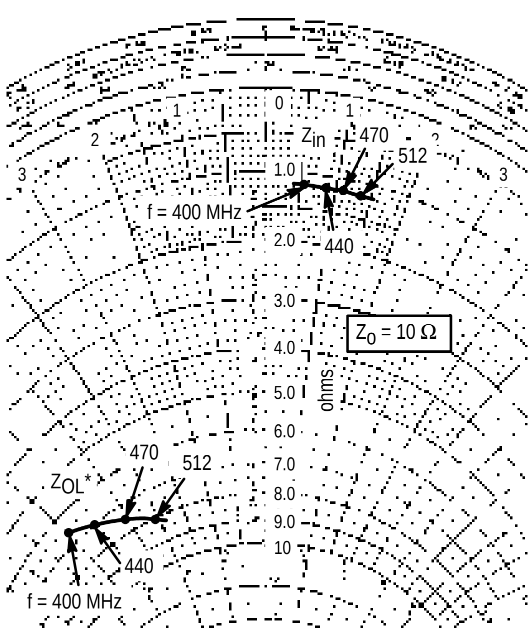


Figure 5. Typical Broadband Circuit Performance



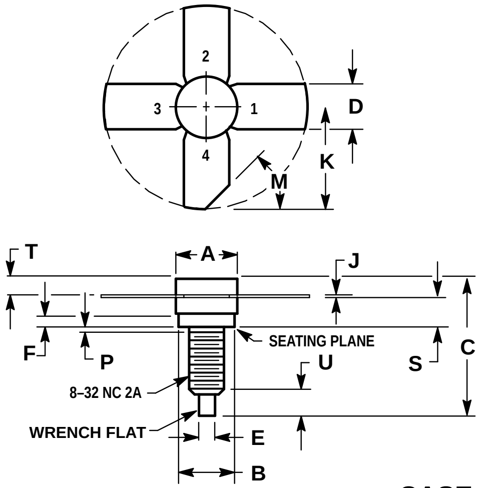
V_{CC} = 12.5 Vdc
P_{out} = 5.0 W

f MHz	Z_{in} Ohms	Z_{OL}* Ohms
400	1.18 + j0.54	6.7 – j6.9
440	1.19 + j0.88	7.05 – j6.1
470	1.19 + j1.11	7.6 – j5.1
512	1.19 + j1.35	8.1 – j4.1

Z_{OL}* = Conjugate of the optimum load impedance into which the device output operates at a given output power, voltage and frequency.

Figure 6. Series Equivalent Input/Output Impedance

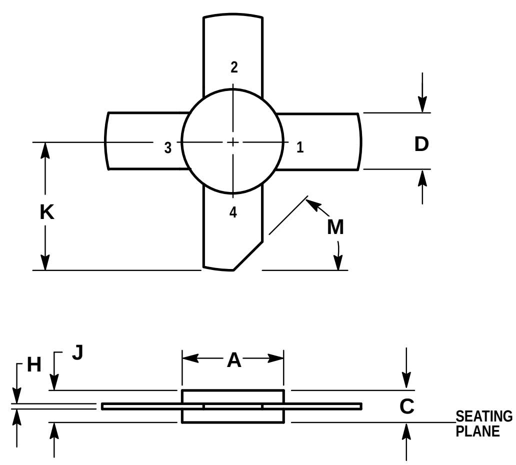
PACKAGE DIMENSIONS



STYLE 1:
PIN 1. EMITTER
2. BASE
3. EMITTER
4. COLLECTOR

DIM	MILLIMETERS MIN	MILLIMETERS MAX	INCHES MIN	INCHES MAX
A	7.06	7.26	0.278	0.286
B	6.20	6.50	0.244	0.256
C	14.99	16.51	0.590	0.650
D	5.46	5.96	0.215	0.235
E	1.40	1.65	0.055	0.065
G	1.52	—	0.060	—
J	0.08	0.17	0.003	0.007
K	11.05	—	0.435	—
M	45° NOM		45° NOM	
P	—	1.27	—	0.050
S	3.00	3.25	0.118	0.128
T	1.40	1.77	0.055	0.070
U	2.92	3.68	0.115	0.145

CASE 244–04
ISSUE J
MRF652



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. SEATING PLANE = GROUND AND IS CONNECTED TO PIN 1 AND 3.

DIM	INCHES MIN	INCHES MAX	MILLIMETERS MIN	MILLIMETERS MAX
A	0.271	0.286	6.88	7.26
C	0.112	0.136	2.84	3.45
D	0.215	0.235	5.46	5.97
H	0.055	0.065	1.40	1.65
J	0.003	0.007	0.08	0.18
K	0.435	—	11.05	—
M	45° REF		45° REF	

STYLE 1:
PIN 1. EMITTER
2. BASE
3. EMITTER
4. COLLECTOR

CASE 249–06
ISSUE H
MRF652S

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